




I hereby certify that this paper (along with any paper referred to as being attached or enclosed) is being deposited with the U.S. Postal Service on the date shown below with sufficient postage as First Class Mail, in an envelope addressed to: MS Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Dated: September 21, 2006 Signature: 

(Dennis M. Smid)

Docket No.: SONYJP 3.3-1079
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Tokura et al.

Application No.: 10/521,141

Filed: May 18, 2005

For: METHOD FOR DECORATING SURFACE OF
MOLD AND MOLD

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: Group Art Unit: 1763
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: Examiner: A. W. Olsen
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MS Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT

Dear Sir:

In response to the official action mailed March 22, 2006, applicants submit the following amendments and remarks.